

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HIDEKI TAKANO	09/11/2011
SHUNSUKE AKIFUJI	09/16/2011
TATSUAKI OSAFUNE	09/14/2011
RECEIVING PARTY DATA	
Name:	HITACHI AUTOMOTIVE SYSTEMS, LTD.
Street Address:	2520, TAKABA
City:	HITACHINAKA-SHI, IBARAKI
State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13216612
CORRESPONDENCE DATA	
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Address Line 1:	3000 K ST., NW
Address Line 2:	SUITE 600
Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20007
ATTORNEY DOCKET NUMBER:	091715-0159
NAME OF SUBMITTER:	P. SHIEK FOR W. T. ELLIS
Total Attachments: 1 source=assign#page1.tif	

OP \$40.00 13216612

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PATENT
REEL: 027057 FRAME: 0988

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi Automotive Systems, Ltd., a corporation organized under the laws of Japan, located at 2520 Takaba, Hitachinaka-shi, Ibaraki, Japan receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi Automotive Systems, Ltd., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

METHOD FOR COMMUNICATION BETWEEN SERVER PROCESSING APPARATUS AND CLIENT PROCESSING APPRATUS

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Hitachi Automotive Systems, Ltd.,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi Automotive Systems, Ltd.,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) Hideki Takano Hideki TAKANO

September 11, 2011

2) Shunsuke Akifuji Shunsuke AKIFUJI

September 16, 2011

3) Tatsuaki Osaifune Tatsuaki OSAFUNE

September 17, 2011

4) _____

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10) _____
